384MHz – 768MHz Low Phase Noise LVDS VCXO (12 – 24MHz Crystal)

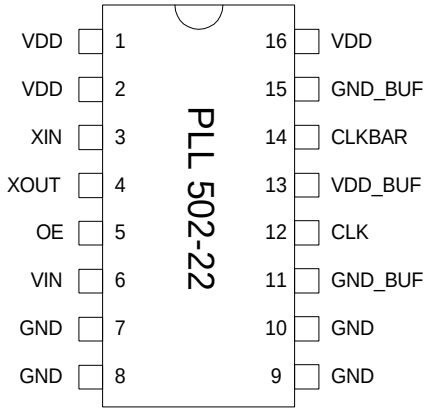
FEATURES

- Low phase noise output for the 384MHz to 768MHz range (-130 dBc at 10kHz offset).
- LVDS output.
- 12 to 24MHz crystal input.
- Integrated crystal load capacitor: no external load capacitor required.
- Output Enable selector.
- Wide pull range (+/-180 ppm)
- 3.3V operation.
- Available in 16 Pin TSSOP or SOIC.

DESCRIPTION

The PLL502-22 is a monolithic low jitter and low phase noise (-130dBc/Hz @ 10kHz offset) VCXO IC with LVDS output, for 384MHz to 768MHz output range. It allows the control of the output frequency with an input voltage (VIN), using a low cost crystal. The chip provides a pullable output at a frequency of F_{XIN} x 32. This makes the PLL502-22 ideal for a wide range of applications, including 622.08MHz for SONET.

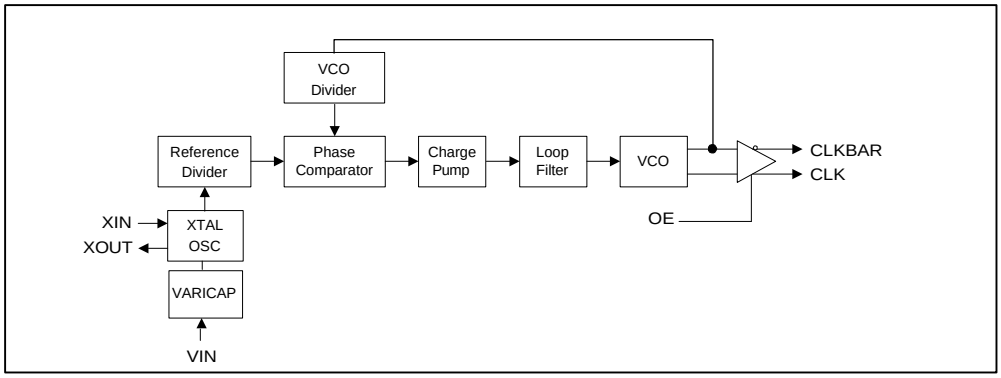
PIN CONFIGURATION



$F_{OUT} = F_{XIN}$ x 32

OE (Pin 5)	Output State
0	Tri-state
1 (Default)	Output enabled

BLOCK DIAGRAM



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PIN DESCRIPTIONS

Name	Number	Type	Description
VDD	1,2,16	P	+3.3V Power supply connectors.
XIN	3	I	Crystal input pin.
XOUT	4	I	Crystal output pin.
OE	5	I	Output enable input pin. Disables (tri-state) output when low. Internal pull-up enables output by default if pin is not connected to low.
VIN	6	I	Frequency control voltage input pin.
GND	7,8,9,10	P	GND Power connectors.
GND_BUF	11,15	P	GND connector for output buffers.
CLK	12	O	True clock output pin.
VDD_BUF	13	P	+3.3V Power supply connector for output buffers.
CLKB	14	O	Complementary clock output pin.

ELECTRICAL SPECIFICATIONS

1. Absolute Maximum Ratings

PARAMETERS	SYMBOL	MIN.	MAX.	UNITS
Supply Voltage	V_{DD}		7	V
Input Voltage, dc	V_I	V_{SS}-0.5	V_{DD}+0.5	V
Output Voltage, dc	V_O	V_{SS}-0.5	V_{DD}+0.5	V
Storage Temperature	T_S	-65	150	°C
Ambient Operating Temperature	T_A	0	70	°C
Junction Temperature	T_J		125	°C
Lead Temperature (soldering, 10s)			260	°C
Input Static Discharge Voltage Protection			2	kV

Exposure of the device under conditions beyond the limits specified by Maximum Ratings for extended periods may cause permanent damage to the device and affect product reliability. These conditions represent a stress rating only, and functional operations of the device at these or any other conditions above the operational limits noted in this specification is not implied.

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2. Crystal Specifications

PARAMETERS	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Crystal Resonator Frequency	F_{XIN}	Parallel Fundamental Mode	12		24	MHz
Crystal Loading Rating	$C_{L\ (xtal)}$			TBD		pF
Crystal Pullability	$C_0/C_{1\ (xtal)}$	AT cut			250	-
Recommended ESR	R_E	AT cut			30	Ω

3. Voltage Control Crystal Oscillator

PARAMETERS	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
VCXO Stabilization Time *	$T_{VCXOSTB}$	From power valid		10		ms
Output Frequency Synthesis Error		(Unless otherwise noted in Frequency Table)			±30	ppm
VCXO Tuning Range		F_{XIN} = 12 - 24MHz; XTAL C_0/C_1 < 250	380			ppm
CLK output pullability		0V ≤ VCON ≤ 3.3V	±190			ppm
Linearity				5	10	%
VCXO Tuning Characteristic				115		ppm/V

Note: Parameters denoted with an asterisk (*) represent nominal characterization data and are not production tested to any specific limits.

4. General Electrical Specifications

PARAMETERS	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Supply Current, Dynamic (with Loaded Outputs)	I_{DD}	LVDS			60	mA
Operating Voltage	V_{DD}		3.13		3.47	V
Output Clock Duty Cycle		@ 1.25V (LVDS)	45	50	55	%
Short Circuit Current				±50		mA

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5. Jitter and Phase Noise specification

PARAMETERS	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Period jitter RMS	With capacitive decoupling between VDD and GND.		7		ps
Accumulated jitter RMS	With capacitive decoupling between VDD and GND. Over 10,000 cycles.		11		ps
Phase Noise relative to carrier	622MHz @100Hz offset		-80		dBc/Hz
Phase Noise relative to carrier	622MHz @1kHz offset		-109		dBc/Hz
Phase Noise relative to carrier	622MHz @10kHz offset		-130		dBc/Hz
Phase Noise relative to carrier	622MHz @100kHz offset		-132		dBc/Hz

6. LVDS Electrical Characteristics

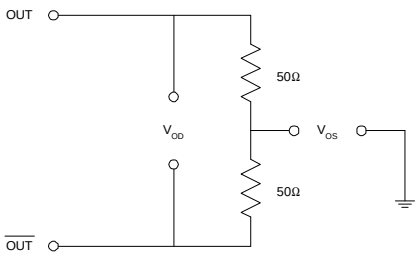
PARAMETERS	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Output Differential Voltage	V_{OD}	R_L = 100 Ω (see figure)	247	355	454	mV
V_{DD} Magnitude Change	ΔV_{OD}		-50		50	mV
Output High Voltage	V_{OH}			1.4	1.6	V
Output Low Voltage	V_{OL}		0.9	1.1		V
Offset Voltage	V_{OS}		1.125	1.2	1.375	V
Offset Magnitude Change	ΔV_{OS}		0	3	25	mV
Power-off Leakage	I_{OXD}	V_{out} = V_{DD} or GND, V_{DD} = 0V		±1	±10	uA
Output Short Circuit Current	I_{OSD}			-5.7	-8	mA

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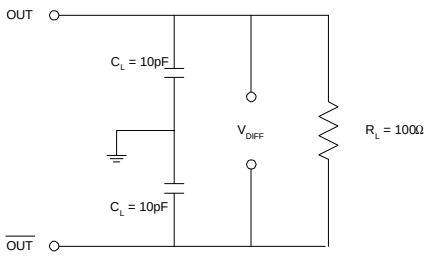
7. LVDS Switching Characteristics

PARAMETERS	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Differential Clock Rise Time	t_r	R_L = 100 Ω C_L = 10 pF (see figure)	0.2	0.7	1.0	ns
Differential Clock Fall Time	t_f		0.2	0.7	1.0	ns

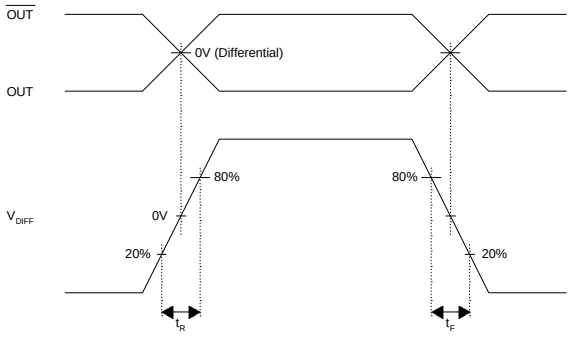
LVDS Levels Test Circuit



LVDS Switching Test Circuit



LVDS Transistion Time Waveform

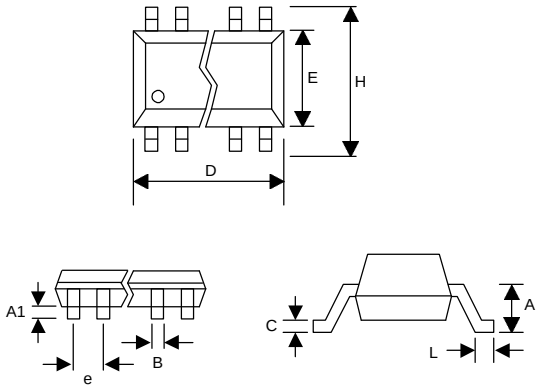


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PACKAGE INFORMATION

16 PIN Narrow SOIC, TSSOP (mm)

	SOIC		TSSOP	
Symbol	Min.	Max.	Min.	Max.
A	1.35	1.75	-	1.20
A1	0.10	0.25	0.05	0.15
B	0.33	0.51	0.19	0.30
C	0.19	0.25	0.09	0.20
D	9.80	10.00	4.90	5.10
E	3.80	4.00	4.30	4.50
H	5.80	6.20	6.40 BSC	
L	0.40	1.27	0.45	0.75
e	1.27 BSC		0.65 BSC	



ORDERING INFORMATION

For part ordering, please contact our Sales Department:
47745 Fremont Blvd., Fremont, CA 94538, USA
Tel: (510) 492-0990 Fax: (510) 492-0991

PART NUMBER
The order number for this device is a combination of the following:
Device number, Package type and Operating temperature range

PLL502-22 S C XX

PART NUMBER

REVISION CODE
(when applicable)

TEMPERATURATURE
C=COMMERCIAL
M=MILITARY
I=INDUSTRAL

PACKAGE TYPE
S=SOIC. O=TSSOP

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